

=> fil wpix

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FILE LAST UPDATED: 19 NOV 2007 <20071119/UP>  
MOST RECENT THOMSON SCIENTIFIC UPDATE: 200774 <200774/DW>  
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20061231/UPIC, 20070601/UPIC and 20071001/UPIC. <<<

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df](http://www.stn-international.com/archive/presentations/DWPIAnaVist2_0710.pdf)

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(FILE 'HOME' ENTERED AT 12:16:54 ON 21 NOV 2007)

FILE 'HCAPLUS' ENTERED AT 12:17:03 ON 21 NOV 2007  
L1 1 SEA ABB=ON PLU=ON US2004241507/PN  
D IALL

FILE 'WPIX' ENTERED AT 12:17:40 ON 21 NOV 2007  
L2 1 SEA ABB=ON PLU=ON US20040241507/PN  
D IFULL

FILE 'HCAPLUS' ENTERED AT 12:25:19 ON 21 NOV 2007  
L3 20224 SEA ABB=ON PLU=ON (STORE# OR STORING OR STORAG? OR  
RETRIEV? OR RESTOR?) (2A) (H OR HYDROGEN OR H2)  
L4 26996 SEA ABB=ON PLU=ON (SI OR SILICON) (5A) (PORO? OR PORE OR  
VOID# OR HOLE# OR SPONGELIKE OR SPONG# OR PERVIOUS)  
L5 12 SEA ABB=ON PLU=ON L3 AND L4  
L6 QUE ABB=ON PLU=ON SURFAC?  
L7 6 SEA ABB=ON PLU=ON L5 AND L6  
L8 12 SEA ABB=ON PLU=ON L5 OR L7

FILE 'WPIX' ENTERED AT 12:37:49 ON 21 NOV 2007  
L9 6645 SEA ABB=ON PLU=ON (STORE# OR STORING OR STORAG? OR  
RETRIEV? OR RESTOR?) (2A) (H OR HYDROGEN)  
L10 9014 SEA ABB=ON PLU=ON (SI OR SILICON) (5A) (PORO? OR PORE OR  
VOID# OR HOLE# OR SPONGELIKE OR SPONG# OR PERVIOUS)  
L11 8 SEA ABB=ON PLU=ON L9 AND L10  
L12 4 SEA ABB=ON PLU=ON L11 AND L6  
L13 8 SEA ABB=ON PLU=ON L11 OR L12  
L14 6 SEA ABB=ON PLU=ON L13 AND (PY<=2003 OR PRY<=2003 OR  
AY<=2003)

FILE 'HCAPLUS' ENTERED AT 12:39:44 ON 21 NOV 2007  
L15 7 SEA ABB=ON PLU=ON L8 AND (PY<=2003 OR PRY<=2003 OR  
AY<=2003)

FILE 'COMPENDEX' ENTERED AT 12:40:26 ON 21 NOV 2007  
L16 5554 SEA ABB=ON PLU=ON (STORE# OR STORING OR STORAG? OR  
RETRIEV? OR RESTOR?) (2A) (H OR HYDROGEN)  
L17 8877 SEA ABB=ON PLU=ON (SI OR SILICON) (5A) (PORO? OR PORE OR  
VOID# OR HOLE# OR SPONGELIKE OR SPONG# OR PERVIOUS)  
L18 5 SEA ABB=ON PLU=ON L16 AND L17  
L19 3 SEA ABB=ON PLU=ON L18 AND L6  
L20 1 SEA ABB=ON PLU=ON (L18 OR L19) AND (PY<=2003 OR  
PRY<=2003 OR AY<=2003)

FILE 'JAPIO' ENTERED AT 12:43:42 ON 21 NOV 2007  
L21 5548 SEA ABB=ON PLU=ON (STORE# OR STORING OR STORAG? OR  
RETRIEV? OR RESTOR?) (2A) (H OR HYDROGEN)  
L22 5033 SEA ABB=ON PLU=ON (SI OR SILICON) (5A) (PORO? OR PORE OR  
VOID# OR HOLE# OR SPONGELIKE OR SPONG# OR PERVIOUS)  
L23 0 SEA ABB=ON PLU=ON L21 AND L22

FILE 'INSPEC' ENTERED AT 12:44:02 ON 21 NOV 2007  
L24 5269 SEA ABB=ON PLU=ON (STORE# OR STORING OR STORAG? OR  
RETRIEV? OR RESTOR?) (2A) (H OR HYDROGEN)  
L25 14182 SEA ABB=ON PLU=ON (SI OR SILICON) (5A) (PORO? OR PORE OR  
VOID# OR HOLE# OR SPONGELIKE OR SPONG# OR PERVIOUS)  
L26 7 SEA ABB=ON PLU=ON L24 AND L25  
L27 4 SEA ABB=ON PLU=ON L26 AND L6  
L28 4 SEA ABB=ON PLU=ON (L26 OR L27) AND PY<=2003

FILE 'PASCAL' ENTERED AT 12:44:49 ON 21 NOV 2007  
L29 4501 SEA ABB=ON PLU=ON (STORE# OR STORING OR STORAG? OR  
RETRIEV? OR RESTOR?) (2A) (H OR HYDROGEN)  
L30 6115 SEA ABB=ON PLU=ON (SI OR SILICON) (5A) (PORO? OR PORE OR  
VOID# OR HOLE# OR SPONGELIKE OR SPONG# OR PERVIOUS)  
L31 2 SEA ABB=ON PLU=ON L29 AND L30  
D SCA

FILE 'WPIX' ENTERED AT 12:45:37 ON 21 NOV 2007  
SEL L14 PN,AP

FILE 'HCAPLUS' ENTERED AT 12:45:49 ON 21 NOV 2007  
L32 5 SEA ABB=ON PLU=ON (WO2004-FR50358/AP OR WO2004-US17365/  
L33 5 SEA ABB=ON PLU=ON L15 NOT L32

FILE 'HCAPLUS, COMPENDEX, INSPEC, PASCAL' ENTERED AT 12:46:37 ON 21  
NOV 2007  
L34 9 DUP REM L33 L20 L28 L31 (3 DUPLICATES REMOVED)

=> d l14 ifull 1-6

L14 ANSWER 1 OF 6 WPIX COPYRIGHT 2007 THE THOMSON CORP on STN  
ACCESSION NUMBER: 2005-145016 [16] WPIX  
DOC. NO. CPI: C2005-047264 [16]  
DOC. NO. NON-CPI: N2005-123171 [16]  
TITLE: Hydrogen reservoir made of a nano-structured  
silicon able to store hydrogen,

notably for fuel cells and hydrogen motors  
incorporating such reservoirs

DERWENT CLASS: E36; J06; L03; Q68; Q69; X16

INVENTOR: LYSENKO V; TURPIN C; TURPIN C J; TURPIN C J P P;  
TURPIN C J P

PATENT ASSIGNEE: (CNRS-C) CENT NAT RECH SCI; (CNRS-C) CNRS CENT NAT  
RECH SCI; (NAPO-N) INST NAT POLYTECHNIQUE TOULOUSE;  
(LYSE-I) LYSENKO V; (TURP-I) TURPIN C J P

COUNTRY COUNT: 107

## PATENT INFORMATION:

PATENT NO	KIND	DATE	WEEK	LA	PG	MAIN IPC
FR 2858313	A1	20050204	(200516) *	FR	18	[0]
WO 2005012163	A2	20050210	(200516)	FR		
EP 1648815	A2	20060426	(200628)	FR		
JP 2007500323	W	20070111	(200707)	JA	12	
US 20070059859	A1	20070315	(200722)	EN		

## APPLICATION DETAILS:

PATENT NO	KIND	APPLICATION	DATE
FR 2858313	A1	FR 2003-50375	20030728
EP 1648815	A2	EP 2004-767919	20040727
WO 2005012163	A2	WO 2004-FR50358	20040727
EP 1648815	A2	WO 2004-FR50358	20040727
JP 2007500323	W	WO 2004-FR50358	20040727
JP 2007500323	W	JP 2006-521636	20040727
US 20070059859	A1	WO 2004-FR50358	20040727
US 20070059859	A1	US 2006-566041	20061013

## FILING DETAILS:

PATENT NO	KIND	PATENT NO
EP 1648815	A2 Based on	WO 2005012163 A
JP 2007500323	W Based on	WO 2005012163 A

PRIORITY APPLN. INFO: FR 2003-50375 20030728

INT. PATENT CLASSIF.:

IPC ORIGINAL: C01B0003-00 [I,A]; C01B0003-00 [I,C]; C01B0033-00  
[I,C]; C01B0033-02 [I,A]; F17C0011-00 [I,A];  
F17C0011-00 [I,C]; H01L0051-05 [I,C]; H01L0051-40  
[I,A]; H01M0008-04 [I,A]; H01M0008-04 [I,C]

IPC RECLASSIF.: C01B0003-00 [I,A]; C01B0003-00 [I,C]; C01B0033-00  
[I,C]; C01B0033-02 [I,A]

## BASIC ABSTRACT:

FR 2858313 A1 UPAB: 20060121

NOVELTY - A hydrogen reservoir is made up of a substance  
able to **store hydrogen**. The substance is made  
up of nano-structured silicon.

DETAILED DESCRIPTION - INDEPENDENT CLAIMS are included for  
(a) fabrication of the hydrogen reservoir; and  
(b) a process for utilization of the hydrogen reservoir.

USE - Storage and release of hydrogen for applications such  
as fuel cells or fuel cell systems and hydrogen motors or hydrogen  
motor systems incorporating a hydrogen reservoir (all claimed),  
notably for portable devices such as telephones, computers and

small electronic devices, and land transport systems.

**ADVANTAGE** - The invention provides a hydrogen reservoir for which the volume and mass capacities are comparable or better than conventional **hydrogen storage** systems. The storage can be obtained in a simple manner and at atmospheric pressure, thus providing improved security. It may be fabricated in large quantities at low cost, and is compatible with production of fuel cells with different power ranges.

**TECHNOLOGY FOCUS:**

**INORGANIC CHEMISTRY - Preferred Hydrogen**

**Storage Substance:** The substance may be made up of a nanostructure of meso-porous and/or nano-porous **silicon**, or a porous and compacted nano-structured **silicon**, or a porous, crushed and compacted nano-structured **silicon**.

**Preferred Utilization of the Hydrogen Reservoir:** The hydrogen is released from the reservoir by causing rupture of the chemical bonds between the hydrogen and the silicon. Rupture is caused by the application of chemical, thermal, mechanical, radiation or electrical energy (claimed). The reservoir may be recharged by contacting the substance with an acid.

**FILE SEGMENT:** CPI; GMPI; EPI

**MANUAL CODE:** CPI: E31-A02; E31-P06A; J06-B06A; L03-E04; L03-H05  
EPI: X16-C15C3

L14 ANSWER 2 OF 6 WPIX COPYRIGHT 2007 THE THOMSON CORP on STN  
**ACCESSION NUMBER:** 2005-011597 [01] WPIX  
**DOC. NO. CPI:** C2005-003190 [01]  
**DOC. NO. NON-CPI:** N2005-009323 [01]  
**TITLE:** Elemental **hydrogen storage** and **retrieval** system for use in auxiliary power unit in vehicle comprises **hydrogen storage** component including silicon  
**DERWENT CLASS:** E36; J06; L03; X16; X21; X22  
**INVENTOR:** CHILCOTT D W; CHRISTENSON J C; SCHUBERT P J; SHUBERT P J  
**PATENT ASSIGNEE:** (CHIL-I) CHILCOTT D W; (CHRI-I) CHRISTENSON J C; (DELP-N) DELPHI TECHNOLOGIES INC; (SCHU-I) SCHUBERT P J  
**COUNTRY COUNT:** 107

**PATENT INFORMATION:**

PATENT NO	KIND	DATE	WEEK	LA	PG	MAIN IPC
US 20040241507	A1	20041202	(200501)*	EN	15	[9]
WO 2005035439	A2	20050421	(200527)	EN		
EP 1638886	A2	20060329	(200623)	EN		
JP 2007526426	W	20070913	(200762)	JA	18	

**APPLICATION DETAILS:**

PATENT NO	KIND	APPLICATION	DATE
US 20040241507	A1 Provisional	US 2003-474721P	
20030530			
US 20040241507	A1 Provisional	US 2003-477156P	
20030609			
US 20040241507	A1	US 2004-824719	20040415
EP 1638886	A2	EP 2004-809430	20040601

WO 2005035439 A2  
 EP 1638886 A2  
 JP 2007526426 W  
 JP 2007526426 W

WO 2004-US17365 20040601  
 WO 2004-US17365 20040601  
 WO 2004-US17365 20040601  
 JP 2006-515096 20040601

## FILING DETAILS:

PATENT NO	KIND	PATENT NO
EP 1638886	A2	WO 2005035439 A
JP 2007526426	W	WO 2005035439 A

PRIORITY APPLN. INFO: US 2004-824719 20040415  
 US 2003-474721P 20030530  
 US 2003-477156P 20030609

## INT. PATENT CLASSIF.:

IPC ORIGINAL: B01J0020-02 [I,A]; B01J0020-02 [I,C]; B01J0020-30 [I,C]; B01J0020-34 [I,A]; B60K0015-03 [I,A]; B60K0015-03 [I,C]; B60K0008-00 [I,A]; B60K0008-00 [I,C]; C01B0003-00 [I,A]; C01B0003-00 [I,C]; C01B0033-00 [I,C]; C01B0033-02 [I,A]; F17C0011-00 [I,A]; F17C0011-00 [I,C]; H01M0008-04 [I,A]; H01M0008-04 [I,C]; H01M0008-10 [I,A]; H01M0008-10 [I,C]; H01M0008-12 [I,A]; H01M0008-12 [I,C]  
 IPC RECLASSIF.: B29C0047-30 [I,A]; B29C0047-30 [I,C]; H01M0006-20 [I,A]; H01M0006-20 [I,C]; H01M0008-06 [I,A]; H01M0008-06 [I,C]; H01M0008-12 [N,A]; H01M0008-12 [N,C]

## BASIC ABSTRACT:

US 20040241507 A1 UPAB: 20060121

NOVELTY - An elemental **hydrogen storage** and **retrieval** system comprises a **hydrogen storage** component (50) including silicon (54).

DETAILED DESCRIPTION - INDEPENDENT CLAIMS are also included for:

(1) a vehicle comprising an auxiliary power unit including a fuel cell system for combining hydrogen and oxygen to provide electrical power and a system for storing and **retrieving** element **hydrogen** for supplying hydrogen to the fuel cell system; and

(2) a method for extruding silicon rods comprising providing a reservoir for receiving molten silicon; providing apertures in the wall of the reservoir; and subjecting the molten silicon within the reservoir to pressure, gravity and/or centrifugal force to cause molten silicon to be extruded in rod shapes through the apertures.

USE - For use in an auxiliary power unit for generating electrical power in a vehicle (claimed).

ADVANTAGE - The adsorption and desorption of elemental hydrogen may be tailored to suit the system to particular applications. The elemental hydrogen remains safely adsorbed within the storage material in the event of catastrophic failure of the system.

DESCRIPTION OF DRAWINGS - The figure shows a schematic view of an elemental **hydrogen storage** and **retrieval** system of the invention.

Light source (14)  
 Current source (16)  
 Voltage source (18)  
 Control system (20)

Housing (44)  
 Inlet/outlet passage (46)  
     Hydrogen storage component (50)  
 Adsorbed hydrogen atoms (52)  
 Silicon (54)  
 Liberated hydrogen atoms (56)

## TECHNOLOGY FOCUS:

MECHANICAL ENGINEERING - Preferred Components: A housing (44) encloses the **hydrogen storage** components. A control system (20) regulates the storing and **retrieval** of **hydrogen** from the **storage** component. The **hydrogen storage** component includes a **porous silicon surface** layer over at least a first portion of the **hydrogen storage** component. The percent void volume of the **surface** layer is 50 %. A second portion of the **hydrogen storage** component includes electronic integrated circuit elements. The **hydrogen storage** component includes silicon columns having an aspect ratio of length to diameter of at least 10. The silicon columns have been formed by extrusion of molten silicon through an orifice. The orifice has a diameter of 1 nm. It is formed in a shape of a triangle, rhombus, square or circle. Light, current and/or voltage release the **stored hydrogen** from the **storage** component. The light is provided by a light-emitting diode at a wavelength of 660 nm. The **hydrogen storage** component is formed from a silicon wafer. The silicon may be derived from molten silicon by crystallization or from silicon waste from the integrated circuit industry. The fuel cell system consists of solid oxide fuel cell system and proton exchange membrane system. The **hydrogen storage** components are distributed into various locations, e.g. floors, fenders, quarter panels, rocker panels, doors, columns, posts, trunk, and/or roof, within the vehicle.

INORGANIC CHEMISTRY - Preferred Materials: The **hydrogen storage** component includes **porous silicon**. The extrusion is carried out in an atmosphere of hydrogen, argon, helium, or neon. The silicon may be in a monocrystalline or polycrystalline form. The silicon has been treated by crushing, milling, treatment with hydrofluoric acid and methanol in the presence of electric current, treatment with potassium hydroxide, treatment with hydrazine, wet etching, dry etching, electrodeposition of a noble metal, e.g. palladium or platinum, conformal vapor deposition of silicon, or non-conformation vapor deposition of silicon.

FILE SEGMENT: CPI; EPI  
 MANUAL CODE: CPI: E11-N; E11-S; E31-A02A; E31-A02B; E31-A05;  
 E31-D01; E31-P06A; J06-B06; L03-E04  
 EPI: X16-C01; X16-C15; X16-E01C1; X21-A01F;  
 X21-B01A; X21-B04; X22-F01; X22-F03

L14 ANSWER 3 OF 6 WPIX COPYRIGHT 2007 THE THOMSON CORP on STN  
 ACCESSION NUMBER: 2004-435981 [41] WPIX  
 DOC. NO. NON-CPI: N2004-344781 [41]  
 TITLE: Polishing pad used for chemical-mechanical  
 polishing of **silicon** wafer, has circular  
**holes** and concentric circular grooves,  
 which are uniformly formed on polishing  
**surface**  
 DERWENT CLASS: P61; U11  
 INVENTOR: HIRAKI H; KATAO Y; YOKOMICHI Y

PATENT ASSIGNEE: (LODE-N) LODEL NITTA KK  
 COUNTRY COUNT: 1

## PATENT INFORMATION:

PATENT NO	KIND	DATE	WEEK	LA	PG	MAIN IPC
JP 2004167605	A	20040617	(200441)*	JA	19	[16]

## APPLICATION DETAILS:

PATENT NO	KIND	APPLICATION	DATE
JP 2004167605 A 20021115		JP 2002-332502	

PRIORITY APPLN. INFO: JP 2002-332502 20021115

INT. PATENT CLASSIF.:

IPC RECLASSIF.: B24B0037-00 [I,A]; B24B0037-00 [I,C]; B24B0053-00 [I,C]; B24B0053-02 [I,A]; H01L0021-02 [I,C]; H01L0021-304 [I,A]

## BASIC ABSTRACT:

JP 2004167605 A UPAB: 20050530

NOVELTY - The polishing pad has several circular holes (H) which store the slurry consisting of grinding particles, and concentric circular grooves (S). The holes and grooves are uniformly distributed on the polishing surface

DETAILED DESCRIPTION - An INDEPENDENT CLAIM is also included for polishing apparatus.

USE - For polishing silicon wafer using polishing apparatus (claimed) such as chemical-mechanical polishing apparatus, in manufacture of semiconductor element.

ADVANTAGE - The polishing rate and flat surface uniformity are improved, by forming both holes and grooves on the polishing surface.

DESCRIPTION OF DRAWINGS - The figure shows a top view of polishing pad. (Drawing includes non-English language text).

polishing pad (1)

holes (H)

grooves (S)

FILE SEGMENT: GMPI; EPI

MANUAL CODE: EPI: U11-C06A1A

L14 ANSWER 4 OF 6 WPIX COPYRIGHT 2007 THE THOMSON CORP on STN

ACCESSION NUMBER: 2004-112950 [12] WPIX

DOC. NO. CPI: C2004-046528 [12]

DOC. NO. NON-CPI: N2004-089886 [12]

TITLE: Granular silicon manufacturing equipment for solar cells, has holes formed in conical portion of nozzle to eject silicon melt solution from melting pot protruded by side o emitting silicone melt solution to emit

DERWENT CLASS: E36; L03; U11; U12

INVENTOR: ARIMUNE H; HAYASHI K; KITAHARA N; SUZUKI T; TANABE H

PATENT ASSIGNEE: (KYOC-C) KYOCERA CORP

COUNTRY COUNT: 1

## PATENT INFORMATION:

PATENT NO	KIND	DATE	WEEK	LA	PG	MAIN IPC
JP 2003335511	A	20031125	(200412)*	JA	7	[11]
<--						
JP 3961342	B2	20070822	(200757)	JA	10	

## APPLICATION DETAILS:

PATENT NO	KIND	APPLICATION	DATE
JP 2003335511	A	JP 2002-145212	
20020520			
JP 3961342	B2	JP 2002-145212	
20020520			

## FILING DETAILS:

PATENT NO	KIND	PATENT NO
JP 3961342	B2 Previous Publ	JP 2003335511 A

PRIORITY APPLN. INFO: JP 2002-145212 20020520

## INT. PATENT CLASSIF.:

IPC ORIGINAL: C01B0033-00 [I,C]; C01B0033-021 [I,A]

IPC RECLASSIF.: C01B0033-00 [I,C]; C01B0033-02 [I,A]; H01L0031-04 [I,A]; H01L0031-04 [I,C]

## BASIC ABSTRACT:

JP 2003335511 A UPAB: 20050528

NOVELTY - A nozzle (d) is formed with holes (e) in a conical portion to eject a silicon melt solution (c) from a melting pot (1) for manufacturing a granular silicon.

DETAILED DESCRIPTION - An INDEPENDENT CLAIM is also included for the granular silicon manufacturing method.

USE - For manufacturing granular silicon for production of solar cells.

ADVANTAGE - Enables ejection of jet of grain shaped silicon through the holes in the nozzle stably. The corrosion of the nozzle hole is prevented, by preventing the wetting of the ejection side of the nozzle with the melt solution. The processing cost of the silicone manufacturing apparatus is reduced.

DESCRIPTION OF DRAWINGS - The figure shows a schematic view of the granular silicon manufacturing equipment. (Drawing includes non-English language text).

melting pot (1)  
silicon melt solution (2)  
nozzle (d)  
hole (e)

storage container (h)

## FILE SEGMENT:

CPI; EPI

## MANUAL CODE:

CPI: E31-P06A; L03-E05B; L04-A01  
EPI: U11-A01A; U12-A02A

L14 ANSWER 5 OF 6 WPIX COPYRIGHT 2007 THE THOMSON CORP on STN

ACCESSION NUMBER: 1997-422589 [39] WPIX

DOC. NO. CPI: C1999-024663 [08]

DOC. NO. NON-CPI: N1999-058865 [08]

TITLE: Fabrication of capacitors for dynamic random access memories (DRAM) - with a silicon deposition



process using silane to improve step coverage and di:silane for increased deposition rate.

DERWENT CLASS: L03; U11; U13

INVENTOR: AHN B; AHN B C; AHN S; AHN S J; KANG M; KANG M S; SHIN H; SHIN H B

PATENT ASSIGNEE: (SMSU-C) SAMSUNG ELECTRONICS CO LTD

COUNTRY COUNT: 4

## PATENT INFORMATION:

PATENT NO	KIND	DATE	WEEK	LA	PG	MAIN IPC
JP 09191092	A	19970722	(199739)*	JA	12	
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US 5854095	A	19981229	(199908)	B EN	13[15]	
<--						
KR 97051991	A	19970729	(199910)	KO		
<--						
KR 97052571	A	19970729	(199910)	KO		
<--						
KR 97054166	A	19970731	(199911)	KO		
<--						
KR 224707	B1	19991015	(200108)	KO		
<--						
TW 393776	A	20000611	(200108)	ZH		
<--						

## APPLICATION DETAILS:

PATENT NO	KIND	APPLICATION	DATE
JP 09191092 A		JP 1996-354567	
19961219			
KR 97051991 A		KR 1995-55683	19951223
KR 97052571 A		KR 1995-59278	19951227
KR 97054166 A		KR 1996-36138	19960828
KR 224707 B1		KR 1996-36138	19960828
TW 393776 A		TW 1996-115782	
19961220			
US 5854095 A		US 1997-778049	
19970102			

PRIORITY APPLN. INFO: KR 1996-36138 19960828  
 KR 1995-55683 19951223  
 KR 1995-59278 19951227

## INT. PATENT CLASSIF.:

MAIN: H01L021-20; H01L021-30; H01L027-108; H01L027-12

IPC RECLASSIF.: H01L0021-02 [I,A]; H01L0021-02 [I,C]; H01L0021-02 [I,C]; H01L0021-205 [I,A]; H01L0021-285 [I,A]; H01L0021-70 [I,C]; H01L0021-70 [I,C]; H01L0021-768 [I,A]; H01L0021-822 [I,A]; H01L0021-8242 [I,A]; H01L0021-8242 [I,A]; H01L0027-04 [I,A]; H01L0027-04 [I,C]; H01L0027-108 [I,A]; H01L0027-108 [I,C]; H01L0027-12 [I,A]; H01L0027-12 [I,C]

## BASIC ABSTRACT:

US 5854095 A UPAB: 20050703

A method for making an integrated memory device comprises;

(a) Forming a memory cell access transistor comprising doped source and drain regions (107) on an integrated circuit substrate. (b) Forming an insulating layer (108,112) with a contact hole exposing

a portion of one of source / drain. (c) Forming a first amorphous polysilicon layer (114A) on the insulating layer using silane to fill the fill the contact hole (113). (d) Forming a second amorphous polysilicon (116A) on the first using disilane. (e) Patterning the two amorphous polysilicon layers to provide a storage electrode connected to the source / drain region through the contact hole. (f) Forming hemispherical grain polysilicon (118) over the storage electrode. (g) Forming a dielectric layer over the storage electrode. (h) Forming a conductive layer on the dielectric layer. The first amorphous polysilicon layer is 500 - 3000 Å thick and formed at 490 - 560 °C, the second is 1000 - 10,000 Å and formed at 480 - 560 °C

USE - DRAM capacitor fabrication.

ADVANTAGE - The use of improves step coverage allowing silicon to fill contact holes with less voids, and the use of disilane increases deposition rate and reduces its variability, and reduces local crystallisation of the silicon increasing its uniformity, all resulting in improved capacitor electrodes.

#### DOCUMENTATION ABSTRACT:

US5854095

A method for making an integrated memory device comprises;

(a) forming a memory cell access transistor comprising doped source and drain regions (107) on an integrated circuit substrate;  
(b) forming an insulating layer (108,112) with a contact hole exposing a portion of one of source / drain;

(c) forming a first amorphous polysilicon layer (114A) on the insulating layer using silane to fill the fill the contact hole (113);

(d) forming a second amorphous polysilicon (116A) on the first using disilane;

(e) patterning the two amorphous polysilicon layers to provide a storage electrode connected to the source / drain region through the contact hole;

(f) forming hemispherical grain polysilicon (118) over the storage electrode;

(g) forming a dielectric layer over the storage electrode;  
and

(h) forming a conductive layer on the dielectric layer. The first amorphous polysilicon layer is 500 - 3000 Å thick and formed at 490 - 560 °C, the second is 1000 - 10,000 Å and formed at 480 - 560 °C

USE

DRAM capacitor fabrication.

ADVANTAGE

The use of improves step coverage allowing silicon to fill contact holes with less voids, and the use of disilane increases deposition rate and reduces its variability, and reduces local crystallisation of the silicon increasing its uniformity, all resulting in improved capacitor electrodes.

FILE SEGMENT: CPI; EPI

L14 ANSWER 6 OF 6 WPIX COPYRIGHT 2007 THE THOMSON CORP on STN

ACCESSION NUMBER: 1987-309417 [44] WPIX

DOC. NO. CPI: C1987-131666 [21]

TITLE: Powder charged reactor - comprises hollow porous ceramic part in vessel, composed of sintered silicon or zirconium carbide(s) for storage of ammonia, hydrogen

DERWENT CLASS: G04; J06; Q78  
INVENTOR: HIGO T; OSHITA T  
PATENT ASSIGNEE: (EBAR-C) EBARA MFG CO LTD  
COUNTRY COUNT: 1

## PATENT INFORMATION:

PATENT NO	KIND	DATE	WEEK	LA	PG	MAIN IPC
JP 62216633	A	19870924	(198744)*	JA	7[11]	
<--						
JP 05009129	B	19930204	(199308)	JA	7	
<--						

## APPLICATION DETAILS:

PATENT NO	KIND	APPLICATION	DATE
JP 62216633 A		JP 1986-58348	19860318
JP 05009129 B		JP 1986-58348	19860318

## FILING DETAILS:

PATENT NO	KIND	PATENT NO
JP 05009129 B	Based on	JP 62216633 A

PRIORITY APPLN. INFO: JP 1986-58348 19860318

## INT. PATENT CLASSIF.:

MAIN: B01J008-02  
IPC RECLASSIF.: B01J0008-02 [I,A]; B01J0008-02 [I,C]; C01B0003-00 [I,A]; C01B0003-00 [I,C]; C04B0038-00 [I,A]; C04B0038-00 [I,C]; F28D0020-00 [I,A]; F28D0020-00 [I,C]

## BASIC ABSTRACT:

JP 62216633 A UPAB: 20050426

Reactor comprises hollow porous ceramic members arranged in vessel and composed of sintered bodies mainly consisting of silicon carbide or zirconium carbide, and powder which is charged inside or outside ceramic members. Space where no powder is charged is in contact with the opening of the vessel.

ADVANTAGE - Heat regeneration and storage of ammonia or hydrogen can be effectively performed.

FILE SEGMENT: CPI; GMPI

MANUAL CODE: CPI: G04-B01; J04-X; J06-B06

=&gt; fil hcap

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FILE LAST UPDATED: 20 Nov 2007 (20071120/ED)

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FILE COVERS 1898 TO DATE.

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=> fil pascal

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FILE COVERS 1977 TO DATE.

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IN THE BASIC INDEX (/BI) FIELD <<<

=> d l34 iall 1-9

L34 ANSWER 1 OF 9 PASCAL COPYRIGHT 2007 INIST-CNRS. ALL RIGHTS  
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ACCESSION NUMBER: 2006-0388026 PASCAL  
COPYRIGHT NOTICE: Copyright .COPYRG. 2006 INIST-CNRS. All rights  
reserved.  
TITLE (IN ENGLISH): The energetics of hydrogen adsorbed in

nanoporous carbon : A simulational study  
Proceedings of the 21st International Conference  
on Amorphous and Nanocrystalline  
Semiconductors-Science and Technology (ICANS 21)

AUTHOR: LOUSTAU Emilye R. L.; ESTRADA Ruben; VALLADARES  
Ariel A.  
MARTINS Rodrigo (ed.); CHU Virginia (ed.);  
FORTUNATO Elvira (ed.); CONDE Joao Pedro (ed.);  
FERREIRA Isabel (ed.)

CORPORATE SOURCE: Instituto de Investigaciones en Materiales,  
Universidad Nacional Autonoma de Mexico, Ciudad  
Universitaria, Apartado Postal 70-360, 04510  
Mexico, D.F, Mexico  
Materials Science Department, FCT-UNL, Campus da  
Caparica, Portugal; INESC Microsistemas e  
Nanotecnologias, Lisbon, Portugal; Department of  
Chemical and Biological Engineering, IST-UTL,  
Lisbon, Portugal

SOURCE: Journal of non-crystalline solids, (2006),  
352(9-20), 1332-1335, 11 refs.  
Conference: 21 International Conference on  
Amorphous and Nanocrystalline Semiconductors,  
Lisbon (Portugal), 4 Sep 2005  
ISSN: 0022-3093 CODEN: JNCSBJ

DOCUMENT TYPE: Journal; Conference

BIBLIOGRAPHIC LEVEL: Analytic

COUNTRY: Netherlands

LANGUAGE: English

AVAILABILITY: INIST-14572, 354000142455191130

ABSTRACT: Porous carbon is considered a promising material  
to **store hydrogen**. It can be  
visualized as a defective relaxed sample and  
therefore some of the methods we have developed  
to deal with **porous silicon**  
are presently applied to this material. Porous  
atomic structures with 50% porosity that, due to  
the size of the supercells fall within the  
regime of nanoporous carbon, are generated using  
our procedure. Two pure nanoporous samples of  
densities 1.75 g/cm.sup.3 and 1.31 g/cm.sup.3  
were hydrogenated, relaxed and their total  
energy obtained. The hydrogenated samples were  
first stripped of the hydrogen atoms and their  
total energy obtained. Then the original samples  
were stripped of the carbon atoms and the total  
energy calculated. From these values the average  
energy per hydrogen atom was then deduced. We  
compare our results to CH bond energies;  
conclusions are drawn.

CLASSIFICATION CODE: 001B80A07Z; Physics; Materials science  
001D06D10; Applied sciences; Energy; Thermal use  
of fuels  
230; Energy

CONTROLLED TERM: Atomic structure; Porosity; **Hydrogen**  
**storage**; Hydrogen additions; Total  
energy; Ab initio calculations; Density  
functional method; Adsorption; Radial  
distribution function; Carbon; Carbon nanotubes;  
Nanoporous materials

process); PUR (Purification or recovery); PREP (Preparation); PROC (Process); USES (Uses)  
(**storage** and recovery; manufacture of **hydrogen storage** compns.)

INDEX TERM: 409-21-2, Silicon carbide (SiC), processes  
7440-21-3, Silicon, processes 12033-89-5, Silicon nitride (Si<sub>3</sub>N<sub>4</sub>), processes 37299-94-8, Silicon boride

ROLE: CPS (Chemical process); PEP (Physical, engineering or chemical process); PROC (Process)  
(substrate; manufacture of **hydrogen storage** compns.)

REFERENCE COUNT: 5 THERE ARE 5 CITED REFERENCES AVAILABLE FOR THIS RECORD.

REFERENCE(S): (1) Bradley; US 6834508 B1 2004 HCAPLUS  
(2) Gamo; US 4946646 A 1990 HCAPLUS  
(3) Jaramillo; J. Comb. Chem 2002, V4, P17 HCAPLUS  
(4) Phillips; US 20040009118 A1 2004 HCAPLUS  
(5) Sawa; US 6030724 A 2000 HCAPLUS

L34 ANSWER 3 OF 9 INSPEC (C) 2007 IET on STN

ACCESSION NUMBER: 2003:7508229 INSPEC

DOCUMENT NUMBER: A2003-04-8630K-004; B2003-02-8410-016

TITLE: Photoelectrochemical characterization of **porous Si**: possible application in photoelectrolysis and **hydrogen storage**

AUTHOR: Mathews, N.R.; Sebastian, P.J.; Mathew, X.; Lugo, J.E. (Energy Res. Center, Univ. Nacional Autonoma de Mexico, Morelos, Mexico)

SOURCE: New Materials for Electrochemical Systems IV. Extended Abstracts of the Fourth International Symposium on New Materials for Electrochemical Systems, 2001, p. 448-51 of xxiii+488 pp., 2 refs.  
Editor(s): Savadogo, O.  
Published by: Ecole Polytechnique de Montreal, Montreal, Que., Canada  
Conference: Proceedings of Fourth International Symposium on New Materials for Electrochemical Systems, Montreal, Que., Canada, 9-13 July 2001

DOCUMENT TYPE: Conference; Conference Article

TREATMENT CODE: Practical; Experimental

COUNTRY: Canada

LANGUAGE: English

ABSTRACT: Electrochemical **hydrogen storage** is envisaged as promising way of **storing hydrogen** in metal hydrides and other solid state storage materials. A photoelectrochemical (PEC) system combines the harvesting of solar energy with the electrolysis of water. There are many semiconductors with appropriate band gap for photoelectrochemical water splitting. In this study **porous silicon** was investigated to evaluate its possible application in a photoelectrochemical system for water splitting

CLASSIFICATION CODE: A8630K Photoelectrochemical conversion; A8640K Hydrogen storage and technology; A8245

Electrochemistry and electrophoresis; A8250  
Photochemistry and radiation chemistry; B8410  
Electrochemical conversion and storage  
CONTROLLED TERM: electrolysis; elemental semiconductors; energy  
gap; hydrogen economy; photoelectrochemical  
cells; photoelectrochemistry; silicon; water  
SUPPLEMENTARY TERM: Si photoelectrochemical cells;  
photoelectrochemical characterization;  
photoelectrolysis; hydrogen storage; metal  
hydrides; solid state storage materials; water  
electrolysis; cathode; anode; energy efficiency;  
semiconductor material; band gap;  
photoelectrochemical water splitting; 1.23 V; Si  
CHEMICAL INDEXING: Si int, Si el  
PHYSICAL PROPERTIES: voltage 1.23E+00 V  
ELEMENT TERMS: Si

L34 ANSWER 4 OF 9 HCAPLUS COPYRIGHT 2007 ACS on STN

ACCESSION NUMBER: 2002:142039 HCAPLUS

DOCUMENT NUMBER: 136:286931

ENTRY DATE: Entered STN: 22 Feb 2002

TITLE: Micro-nanosystems by bulk silicon micromachining

AUTHOR(S): Esashi, Masayoshi

CORPORATE SOURCE: New Industry Creation Hatchery Center (NICHe),  
Tohoku University, Aramaki, Aobaku, Sendai,  
980-8579, Japan

SOURCE: Proceedings of SPIE-The International Society  
for Optical Engineering (2001),  
4592 (Device and Process Technologies for MEMS  
and Microelectronics II), 1-8  
CODEN: PSISDG; ISSN: 0277-786X

PUBLISHER: SPIE-The International Society for Optical  
Engineering

DOCUMENT TYPE: Journal; General Review

LANGUAGE: English

CLASSIFICATION: 76-0 (Electric Phenomena)

ABSTRACT:

A review. Wafer process packaging using elec. feedthrough from glass holes has been applied for micromech. sensors as electrostatically levitating micro motors (10,000 rpm) for rotational gyroscopes. Active catheters and sensors have been developed as maintenance tools used in narrow space. Silicon microstructures made by the deep RIE were used as molds for making ceramic microstructures. **Hydrogen**  
\*\*\*storage\*\*\* capacity of carbon nanotube was measured from the resonant frequency change of thin silicon cantilever which have the carbon nanotube on it. Multiprobe data storage devices have been fabricated using thermal probes of which tip size is 30 nm. The elec. feedthrough from the multiprobe was fabricated in a Pyrex glass plate by using Deep RIE (Reactive Ion Etching) and nickel electroplating. High d. data recording to a phase change media (GeSbTe) was performed.

SUPPL. TERM: review silicon micromachining microstructure  
nanostructure

INDEX TERM: Nanotubes  
(carbon, **hydrogen storage**  
capacity; micro-nanosystems by bulk silicon  
micromachining)

INDEX TERM: Medical goods  
(catheters; micro-nanosystems by bulk silicon  
micromachining)

INDEX TERM: Borosilicate glasses  
 ROLE: CPS (Chemical process); DEV (Device component use); PEP (Physical, engineering or chemical process); PROC (Process); USES (Uses)  
 (elec. feedthrough holes; micro-nanosystems by bulk silicon micromachining)

INDEX TERM: Sputtering  
 (etching, reactive; micro-nanosystems by bulk silicon micromachining)

INDEX TERM: Cantilevers (components)  
 Gyroscopes  
 Micromachining  
 Microsensors  
 Molds (forms)  
 Nanostructures  
 Semiconductor memory devices  
 (micro-nanosystems by bulk silicon micromachining)

INDEX TERM: Electric motors  
 Micromachines  
 (micromotors; micro-nanosystems by bulk silicon micromachining)

INDEX TERM: Ceramics  
 (microstructures; micro-nanosystems by bulk silicon micromachining)

INDEX TERM: Etching  
 (sputter, reactive; micro-nanosystems by bulk silicon micromachining)

INDEX TERM: 127860-51-9, Antimony germanium telluride  
 ROLE: CPS (Chemical process); DEV (Device component use); PEP (Physical, engineering or chemical process); PROC (Process); USES (Uses)  
 (memory devices; micro-nanosystems by bulk silicon micromachining)

INDEX TERM: 7440-21-3, Silicon, processes  
 ROLE: CPS (Chemical process); DEV (Device component use); PEP (Physical, engineering or chemical process); PROC (Process); USES (Uses)  
 (micro-nanosystems by bulk silicon micromachining)

INDEX TERM: 7440-44-0, Carbon, processes  
 ROLE: CPS (Chemical process); DEV (Device component use); PEP (Physical, engineering or chemical process); PROC (Process); USES (Uses)  
 (nanotubes, **hydrogen storage** capacity; micro-nanosystems by bulk silicon micromachining)

INDEX TERM: 1333-74-0, **Hydrogen**, processes  
 ROLE: CPS (Chemical process); PEP (Physical, engineering or chemical process); PROC (Process)  
 (**storage** capacity of carbon nanotubes; micro-nanosystems by bulk silicon micromachining)

REFERENCE COUNT: 16 THERE ARE 16 CITED REFERENCES AVAILABLE FOR THIS RECORD.

REFERENCE(S): (1) Esashi, M; Microsystem Technologies 1994, V1, P2  
 (2) Fukatsu, K; Technical Digest of the 18th Sensor Symposium 2001, P285  
 (3) Haga, Y; Proc of MEMS 2000, P181 HCAPLUS  
 (4) Henmi, H; Sensors and Actuators 1994, VA43, P243  
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- (6) Katsumata, T; The Transaction of The IEE of Japan  
2000, V120-E, P58
- (7) Lee, D; Technical Digest MEMS 2001, P20
- (8) Li, X; Technical Digest MEMS 2001, P98
- (9) Liu, Y; Technical Digest MEMS 2001, P220
- (10) Miyashita, H; J Vac Sci Technol 2000, VB18, P2692
- (11) Nishio, M; Technical Digest of the 17th Sensor  
Symposium 2000, P55
- (12) Ono, T; Technical Digest of the Transducers 2001,  
P1062
- (13) Sugimoto, S; Proc of MEMS 2000, P775 HCAPLUS
- (14) Takimura, N; Technical Digest of the 17th Sensor  
Symposium 2000, P423
- (15) Tanaka, S; Technical Digest of the 17th Sensor  
Symposium 2000, P29
- (16) Yang, J; Applied Physics Letters 2000, V77, P3860  
HCAPLUS

L34 ANSWER 5 OF 9 HCAPLUS COPYRIGHT 2007 ACS on STN DUPLICATE 1

ACCESSION NUMBER: 1999:563355 HCAPLUS  
 DOCUMENT NUMBER: 131:259853  
 ENTRY DATE: Entered STN: 06 Sep 1999  
 TITLE: Hydrogen diffusion in Si and Ni  
 AUTHOR(S): Sebastian, P. J.; Rivera, M. A.  
 CORPORATE SOURCE: Solar-H2-Fuel Cell Area, Morelos, 62580, Mex.  
 SOURCE: Journal of New Materials for Electrochemical  
 Systems (1999), 2(3), 207-210  
 CODEN: JMESFQ; ISSN: 1480-2422  
 PUBLISHER: Journal of New Materials for Electrochemical  
 Systems  
 DOCUMENT TYPE: Journal  
 LANGUAGE: English  
 CLASSIFICATION: 52-2 (Electrochemical, Radiational, and Thermal  
 Energy Technology)  
 Section cross-reference(s): 56, 72

ABSTRACT:

The electrochem. hydrogen absorption - desorption in p-Si and Ni **sponge** was studied by cyclic voltammetry. The voltammogram for Si in alkaline media in the potential range E -1.8 to -0.3 V (vs. SCE) showed an increase in the hydrogen evolution current at a potential of about -1.2 V, which indicates hydrogen evolution/absorption at this potential. The voltammogram for Ni in alkaline media in the potential range E = -1.3 to -0.2 V (vs. SCE) showed a cathodic peak at -1.13 which may be attributed to an absorption prewave due to water electroredn. to Hads.

SUPPL. TERM: electrochem hydrogen absorption desorption silicon  
 nickel; battery anode silicon nickel **hydrogen**  
**storage**; cyclic voltammetry hydrogen  
 absorption desorption  
 INDEX TERM: Absorption  
 Battery anodes  
 Diffusion  
 (hydrogen diffusion in Si and Ni)  
 INDEX TERM: 7440-02-0, Nickel, uses 7440-21-3, Silicon, uses  
 ROLE: DEV (Device component use); PEP (Physical,  
 engineering or chemical process); PROC (Process); USES  
 (Uses)  
 (hydrogen diffusion in Si and Ni)  
 INDEX TERM: 1333-74-0, Hydrogen, processes  
 ROLE: PEP (Physical, engineering or chemical process);

PROC (Process)  
(hydrogen diffusion in Si and Ni)

REFERENCE COUNT: 14 THERE ARE 14 CITED REFERENCES AVAILABLE FOR THIS RECORD.

REFERENCE(S): (1) Breiter, M; Z Elektrochem 1955, V59, P681 HCAPLUS  
(2) Conway, B; J Electroanal Chem 1993, V357, P47 HCAPLUS  
(3) Fukai, Y; The Metals-Hydrogen System 1993  
(4) Hagi, H; Mater Trans 1990, V31, P954  
(5) Hirth, H; Metallurgical Transactions 1980, V11 A, P861  
(6) Huang, J; Int J Hydrogen Energy 1995, V20, P849 HCAPLUS  
(7) Kirchheim, R; Progress in Materials Science 1988, V32, P262  
(8) Lasia, A; J Electrochem Soc 1995, V142, P3393 HCAPLUS  
(9) Song, M; Int J Hydrogen Energy 1995, V20, P221 HCAPLUS  
(10) Subramanian, P; Comprehensive Treatise of Electrochemistry 1981, V4  
(11) Vanhanen, J; Int J Hydrogen Energy 1996, V21, P213 HCAPLUS  
(12) Volk, J; Hydrogen in Metals: Topics in Applied Physics 1978, V28, P29  
(13) Will, F; Z Elektrochem 1960, V64, P258 HCAPLUS  
(14) Yayama, H; Jpn J Appl Phys 1984, V23, P1619 HCAPLUS

L34 ANSWER 6 OF 9 HCAPLUS COPYRIGHT 2007 ACS on STN

ACCESSION NUMBER: 1998:704177 HCAPLUS

DOCUMENT NUMBER: 129:333268

ENTRY DATE: Entered STN: 06 Nov 1998

TITLE: Electrochemical H<sub>2</sub> diffusion in Si and Ni

AUTHOR(S): Rivera, M. A.; Sebastian, P. J.; Solorza, O.; Gamboa, S. A.; Rivera, R.; Olea, A.; Herman, A. M.

CORPORATE SOURCE: Solar-H<sub>2</sub>-Celdas de Combustible, CIE-UNAM, Morelos, Mex.

SOURCE: International Journal of Hydrogen Energy (1998), 23(11), 1019-1024

CODEN: IJHEDX; ISSN: 0360-3199

PUBLISHER: Elsevier Science Ltd.

DOCUMENT TYPE: Journal

LANGUAGE: English

CLASSIFICATION: 52-2 (Electrochemical, Radiational, and Thermal Energy Technology)

Section cross-reference(s): 72

ABSTRACT:

The electrochem. hydrogen absorption-desorption in p-Si and Ni \*\*\*sponge\*\*\* was studied by cyclic voltammetry. The voltammogram for Si in the alkaline media in the potential range  $E = \pm 1.8$  to  $\pm 0.3$  V (vs. SCE) showed an increase in the hydrogen evolution current at a potential of about  $\pm 1.2$  V, which indicates hydrogen evolution/absorption at this potential. The voltammogram for Ni in the alkaline media in the potential range  $E = \pm 1.3$  to  $\pm 0.2$  V (vs SCE) showed a cathodic peak at  $\pm 1.13$  V, which may be attributed to an absorption prewave due to water electroredn. to H<sub>2</sub>.

SUPPL. TERM: battery secondary anode hydrogen

**storage; electrochem hydrogen absorption**  
**desorption silicon nickel**  
**INDEX TERM: Battery anodes**  
**Electrodifussion**  
 (electrochem. hydrogen diffusion in silicon and nickel)  
**INDEX TERM: 7440-02-0, Nickel, uses 7440-21-3, Silicon, uses**  
**ROLE: DEV (Device component use); USES (Uses)**  
 (electrochem. hydrogen diffusion in silicon and nickel)  
**INDEX TERM: 1333-74-0, Hydrogen, processes**  
**ROLE: PEP (Physical, engineering or chemical process);**  
**PROC (Process)**  
 (electrochem. hydrogen diffusion in silicon and nickel)  
**REFERENCE COUNT: 13** THERE ARE 13 CITED REFERENCES AVAILABLE FOR THIS RECORD.  
**REFERENCE(S):** (1) Breiter, M; Z Elektrochem 1955, V59, P681 HCAPLUS  
 (2) Conway, B; Journal Electroanal Chem 1993, V357, P47 HCAPLUS  
 (3) Fukai, Y; The Metals-Hydrogen System 1993  
 (4) Hagi, H; Mater Trans 1990, V31, P954  
 (5) Hirth, H; Metallurgical Transactions 1980, V11A, P861  
 (6) Huang, J; International Journal of Hydrogen Energy 1995, V20, P849 HCAPLUS  
 (7) Kirchheim, R; Progress in Materials Science 1988, V32, P262  
 (8) Lasia, A; Journal Electrochem Soc 1995, V142, P3393 HCAPLUS  
 (9) Song, M; International Journal of Hydrogen Energy 1995, V20, P221 HCAPLUS  
 (10) Subramanian, P; Comprehensive Treatise of Electrochemistry, Chap 8 1981, V4  
 (11) Vanhanen, J; International Journal of Hydrogen Energy 1996, V21, P213 HCAPLUS  
 (12) Volk, J; Hydrogen in Metals: Topics in Applied Physics 1978, V28, P29  
 (13) Will, F; Z Elektrochem 1960, V64, P258 HCAPLUS

L34 ANSWER 7 OF 9 INSPEC (C) 2007 IET on STN

ACCESSION NUMBER: 1998:5967224 INSPEC

DOCUMENT NUMBER: A1998-16-7855-027

TITLE: Influence of successive electron and laser irradiation on the photoluminescence of **porous silicon**

AUTHOR: Kostishko, B.M.; Orlov, A.M. (Ulyanovsk State Univ., Russia)

SOURCE: Technical Physics (March 1998), vol.43, no.3, p. 318-22, 20 refs.

CODEN: TEPHEX, ISSN: 1063-7842

SICI: 1063-7842(199803)43:3L:318:ISEL;1-X

Price: 1063-7842/98/030318-5\$15.00

Doc.No.: S1063-7842(98)00903-9

Translation of: Zhurnal Tekhnicheskoi Fiziki (March 1998), vol.68, no.3, p. 58-63

CODEN: ZTEFA3, ISSN: 0044-4642

SICI: 0044-4642(199803)68:3L:58;1-3

Published by: AIP, USA

DOCUMENT TYPE: Journal; Translation Abstracted

TREATMENT CODE: Experimental  
COUNTRY: United States; Russian Federation  
LANGUAGE: English  
ABSTRACT: The influence of electron irradiation on the light-emitting properties of p- and n-type **porous silicon** prepared by electrochemical etching is investigated. The dose and energy dependences of the electron-stimulated quenching of the photoluminescence (PL) are determined. It is shown that electron treatment of a **porous silicon surface** followed by prolonged storage in air can be used to stabilize the PL. The excitation of photoluminescence by a UV laser acting on sections of **porous silicon** samples subjected to preliminary electron treatment is discovered for the first time. The influence of the electron energy and the power of the laser beam on this process is investigated. The results presented are attributed to variation in the number of radiative recombination centers as a result of the dissociation and **restoration** of **hydrogen**-containing groups on the pore **surface**

CLASSIFICATION CODE: A7855H Photoluminescence in other inorganic materials; A6180F Electron and positron effects; A6180B Ultraviolet, visible and infrared radiation effects

CONTROLLED TERM: electron beam effects; elemental semiconductors; ion recombination; laser beam effects; photoluminescence; porous materials; radiation quenching; silicon

SUPPLEMENTARY TERM: electron irradiation; laser irradiation; photoluminescence excitation; porous Si; restoration; light-emitting properties; electrochemical etching; dose dependence; energy dependence; electron-stimulated quenching; electron treatment; pore surface; UV laser beam; H-containing groups; radiative recombination centers; dissociation; n-Si; p-Si; Si

CHEMICAL INDEXING: Si el

L34 ANSWER 8 OF 9 PASCAL COPYRIGHT 2007 INIST-CNRS. ALL RIGHTS RESERVED. on STN

ACCESSION NUMBER: 1998-0186810 PASCAL  
COPYRIGHT NOTICE: Copyright .COPYRGT. 1998 American Institute of Physics. All rights reserved.

TITLE (IN ENGLISH): Influence of successive electron and laser irradiation on the photoluminescence of **porous silicon**

AUTHOR: KOSTISHKO B. M.; ORLOV A. M.  
CORPORATE SOURCE: Ulyanovsk State University, 432700 Ulyanovsk, Russia  
SOURCE: Technical physics, (1998-03), 43(3), 318-322  
ISSN: 1063-7842 CODEN: TEPHEX

DOCUMENT TYPE: Journal  
BIBLIOGRAPHIC LEVEL: Analytic  
COUNTRY: United States

LANGUAGE: English  
AVAILABILITY: INIST-1186  
ABSTRACT: The influence of electron irradiation on the light-emitting properties of p- and n-type **porous silicon** prepared by electrochemical etching is investigated. The dose and energy dependences of the electron-stimulated quenching of the photoluminescence (PL) are determined. It is shown that electron treatment of a **porous silicon** surface followed by prolonged storage in air can be used to stabilize the PL. The excitation of photoluminescence by a UV laser acting on sections of **porous silicon** samples subjected to preliminary electron treatment is discovered for the first time. The influence of the electron energy and the power of the laser beam on this process is investigated. The results presented are attributed to variation in the number of radiative recombination centers as a result of the dissociation and **restoration** of **hydrogen**-containing groups on the pore surface. .COPYRGHT. 1998 American Institute of Physics.

CLASSIFICATION CODE: 001B70H55A; Physics; Condensed matter physics, Materials science; Optical properties  
001B60A80F; Physics; Condensed matter physics, Materials science; Crystallography  
001B60A80B; Physics; Condensed matter physics, Materials science; Crystallography  
001B60A82F; Physics; Condensed matter physics, Materials science; Crystallography

PHYS. AND ASTRONOM.CODE: 7855A; 6180F; 6180B; 6182F  
CONTROLLED TERM: Experimental study; Silicon; Elemental semiconductors; Porous materials; Photoluminescence; Electron beam effects; Laser beam effects; Radiation quenching; Ion recombination

L34 ANSWER 9 OF 9 HCAPLUS COPYRIGHT 2007 ACS on STN DUPLICATE 2  
ACCESSION NUMBER: 1994:16452 HCAPLUS  
DOCUMENT NUMBER: 120:16452  
ENTRY DATE: Entered STN: 08 Jan 1994  
TITLE: Effect of laser illumination on oxidation of **porous silicon**  
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CORPORATE SOURCE: Dep. Phys., Peking Univ., Beijing, 100871, Peop. Rep. China  
SOURCE: Materials Research Society Symposium Proceedings (1993), 283 (Microcrystalline Semiconductors: Materials Science & Devices), 287-92  
CODEN: MRSPDH; ISSN: 0272-9172  
DOCUMENT TYPE: Journal  
LANGUAGE: English  
CLASSIFICATION: 67-3 (Catalysis, Reaction Kinetics, and

Inorganic Reaction Mechanisms)  
Section cross-reference(s): 73, 78

## ABSTRACT:

The authors studied the effect of laser illumination (argon laser line of 488 nm) on the oxidization process of the inner **surfaces** of **\*\*\*porous\*\*\* silicon** (PS) by measuring the photoluminescence (PL), Fourier-transform IR (FTIR) absorption and x-ray photoelectron spectra and contrasted the variations of PL and FTIR spectra of the PS treated in the following four ways: (1) in vacuum with laser illumination (LI) with power d. of 12 mW/mm<sup>2</sup>; (2) in oxygen with LI; (3) in oxygen without LI (the times for all the above three treatments were 1 h); and (4) **storage** in air for 2 mo without LI. The PL peak of PS showed serious degradation and a blue shift in case 2 but only a moderate degradation and no shift in case 1. The results of FTIR absorption show that the LI in an atmospheric of oxygen enhanced greatly the increase of oxygen-related absorption bands and the decrease of various silicon-hydrogen vibrational mode absorption bands.

SUPPL. TERM: laser illumination oxidn **porous silicon**  
INDEX TERM: Oxidation  
(of **porous silicon**, laser illumination effect on)  
INDEX TERM: 7440-21-3, **Silicon**, reactions  
ROLE: RCT (Reactant); RACT (Reactant or reagent)  
(oxidation of **porous**, laser illumination effect on)

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